



N-Channel Enhancement-Mode Vertical DMOS FET

Features

- ▶ Free from secondary breakdown
- ▶ Low power drive requirement
- ▶ Ease of paralleling
- ▶ Low C_{iss} and fast switching speeds
- ▶ Excellent thermal stability
- ▶ Integral source-drain diode
- ▶ High input impedance and high gain
- ▶ Complementary N- and P-channel devices

Applications

- ▶ Logic level interfaces - ideal for TTL and CMOS
- ▶ Solid state relays
- ▶ Battery operated systems
- ▶ Photo-voltaic drives
- ▶ Analog switches
- ▶ General purpose line drivers
- ▶ Telecom switches

General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Device	Package Option		BV_{DSS}/BV_{DGS} (V)	$R_{DS(ON)}$ (max) (Ω)	$V_{GS(th)}$ (max) (V)
	TO-236AB (SOT-23)	TO-92			
TN2106	TN2106K1-G	TN2106N3-G	60	2.5	2.0

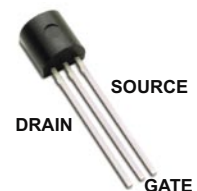
-G indicates package is RoHS compliant ('Green')



Pin Configurations



TO-236AB (SOT-23) (K1)



TO-92 (N3)

Absolute Maximum Ratings

Parameter	Value
Drain-to-source	BV_{DSS}
Drain-to-gate	BV_{DGS}
Gate-to-source	$\pm 20V$
Operating and storage temperature	$-55^{\circ}C$ to $+150^{\circ}C$
Soldering temperature*	$300^{\circ}C$

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

* Distance of 1.6mm from case for 10 seconds.

Product Marking

N1LW W = Code for week sealed
 = "Green" Packaging

TO-236AB (SOT-23) (K1)

TN YY = Year Sealed
2106 WW = Week Sealed
 = "Green" Packaging

TO-92 (N3)

Thermal Characteristics

Package	I _D (continuous) [†] (mA)	I _D (pulsed) (A)	Power Dissipation @T _A = 25°C (W)	θ _{jc} (°C/W)	θ _{ja} (°C/W)	I _{DR} [†] (mA)	I _{DRM} (A)
TO-236AB (SOT-23)	280	0.8	0.36	200	350	280	0.8
TO-92	300	1.0	0.74	125	170	300	1.0

Notes:

[†] I_D (continuous) is limited by max rated T_J.

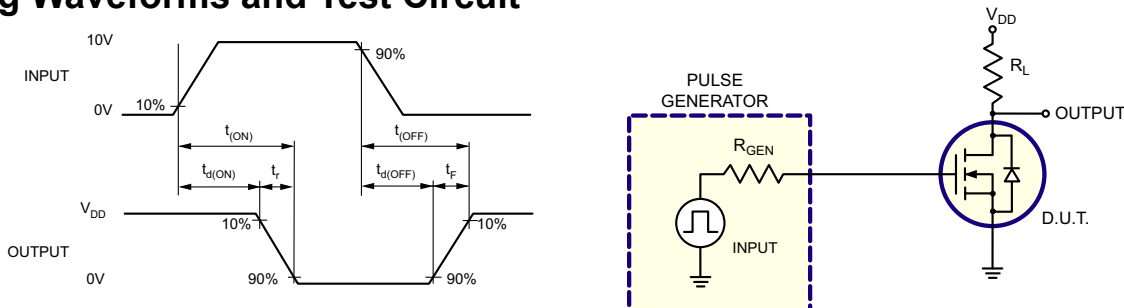
Electrical Characteristics (T_A = 25°C unless otherwise specified)

Sym	Parameter	Min	Typ	Max	Units	Conditions
BV _{DSS}	Drain-to-source breakdown voltage	60	-	-	V	V _{GS} = 0V, I _D = 1.0mA
V _{GS(th)}	Gate threshold voltage	0.6	-	2.0	V	V _{GS} = V _{DS} , I _D = 1.0mA
ΔV _{GS(th)}	Change in V _{GS(th)} with temperature	-	-3.8	-5.5	mV/°C	V _{GS} = V _{DS} , I _D = 1.0mA
I _{GSS}	Gate body leakage	-	0.1	100	nA	V _{GS} = ± 20V, V _{DS} = 0V
I _{DSS}	Zero gate voltage drain current	-	-	1.0	μA	V _{GS} = 0V, V _{DS} = Max Rating
		-	-	100		V _{DS} = 0.8Max Rating, V _{GS} = 0V, T _A = 125°C
I _{D(ON)}	On-state drain current	0.6	-	-	A	V _{GS} = 10V, V _{DS} = 25V
R _{DS(ON)}	Static drain-to-source on-state resistance	-	-	5.0	Ω	V _{GS} = 4.5V, I _D = 200mA
		-	-	2.5		V _{GS} = 10V, I _D = 500mA
ΔR _{DS(ON)}	Change in R _{DS(ON)} with temperature	-	0.70	1.0	%/°C	V _{GS} = 10V, I _D = 500mA
G _{FS}	Forward transductance	150	400	-	mmho	V _{DS} = 25V, I _D = 500mA
C _{ISS}	Input capacitance	-	35	50	pF	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz
C _{OSS}	Common source output capacitance	-	17	25		
C _{RSS}	Reverse transfer capacitance	-	7.0	8.0		
t _{d(ON)}	Turn-on delay time	-	3.0	5.0	ns	V _{DD} = 25V, I _D = 0.5A, R _{GEN} = 25Ω
t _r	Rise time	-	5.0	8.0		
t _{d(OFF)}	Turn-off delay time	-	6.0	9.0		
t _f	Fall time	-	5.0	8.0		
V _{SD}	Diode forward voltage drop	-	1.2	1.8	V	V _{GS} = 0V, I _{SD} = 500mA
t _{rr}	Reverse recovery time	-	400	-	ns	V _{GS} = 0V, I _{SD} = 500mA

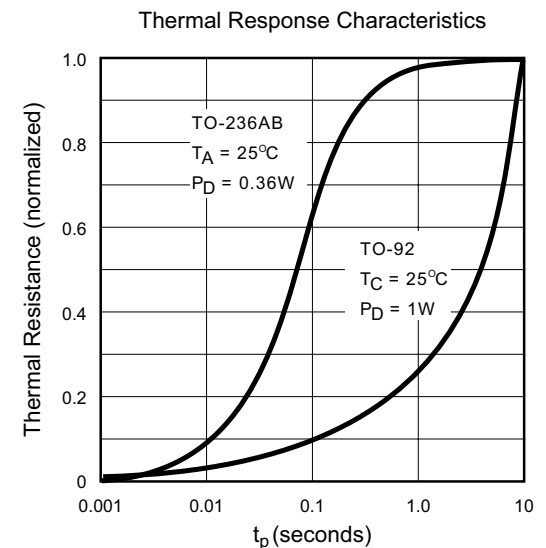
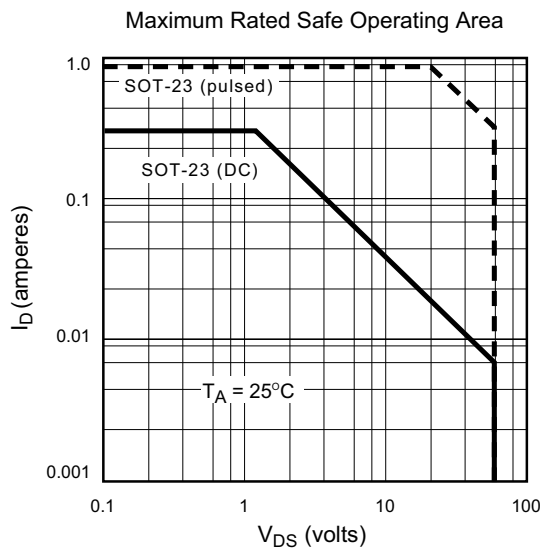
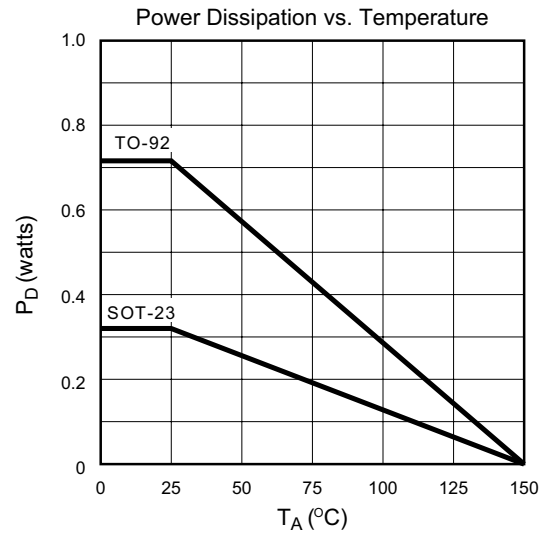
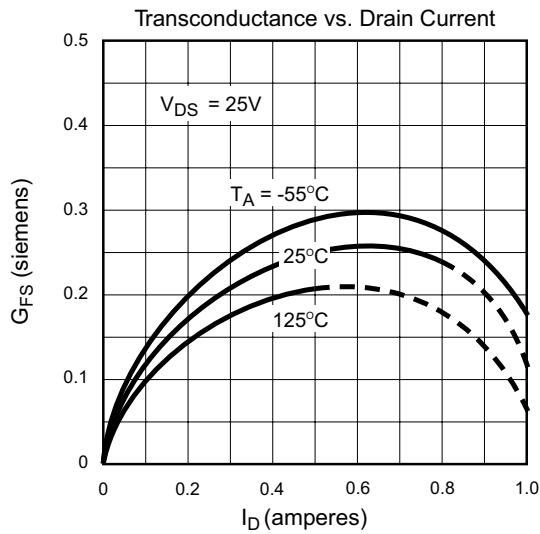
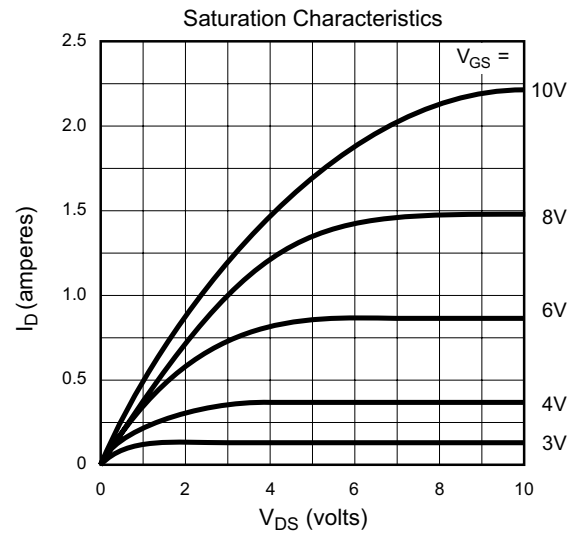
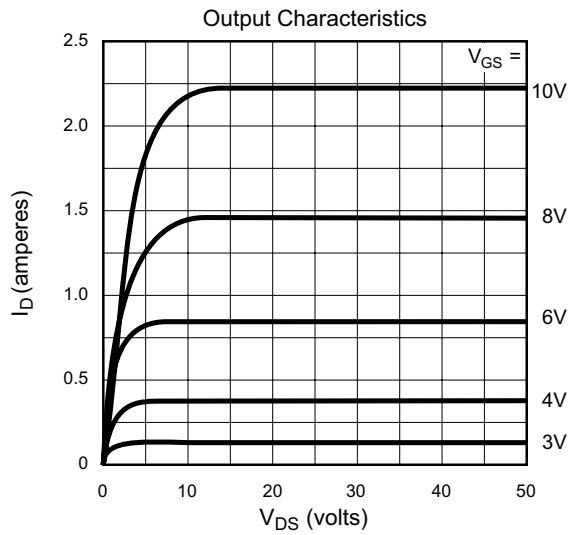
Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)
2. All A.C. parameters sample tested.

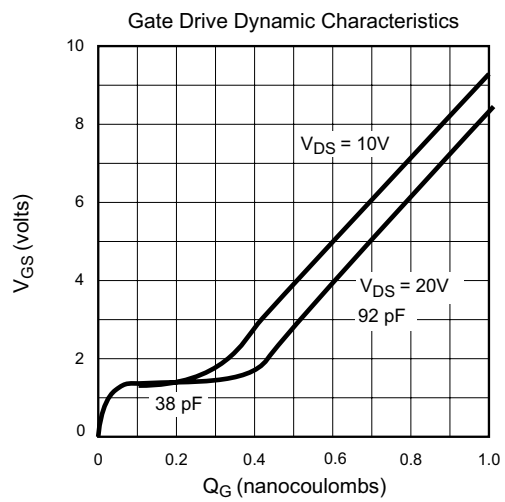
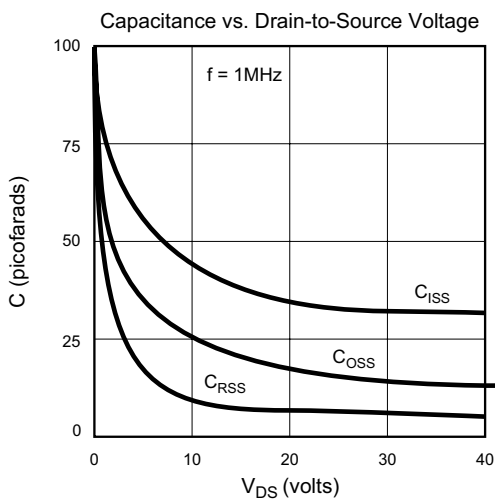
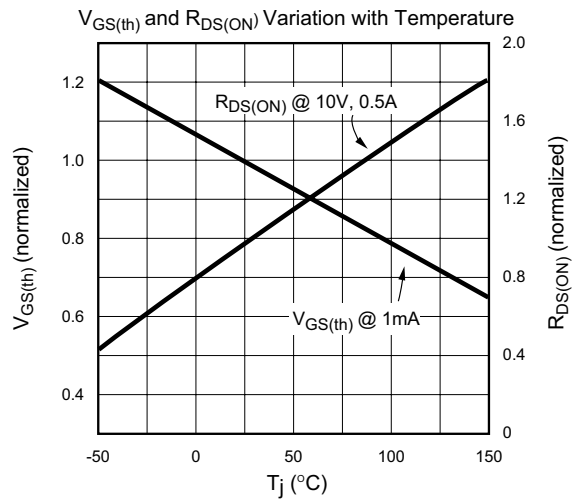
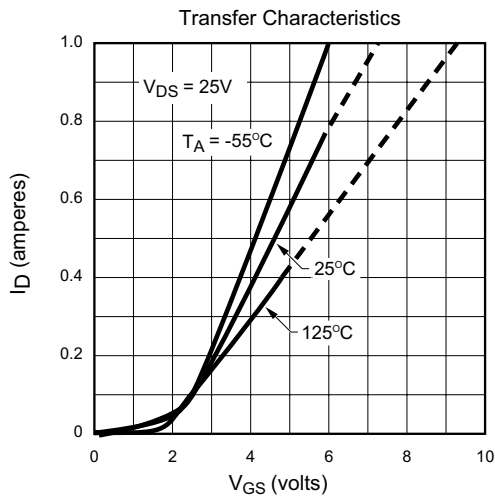
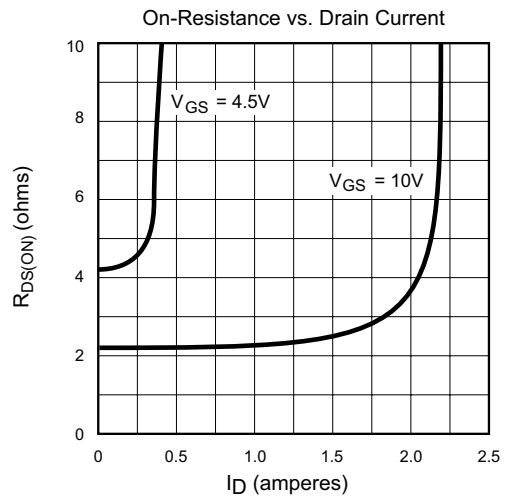
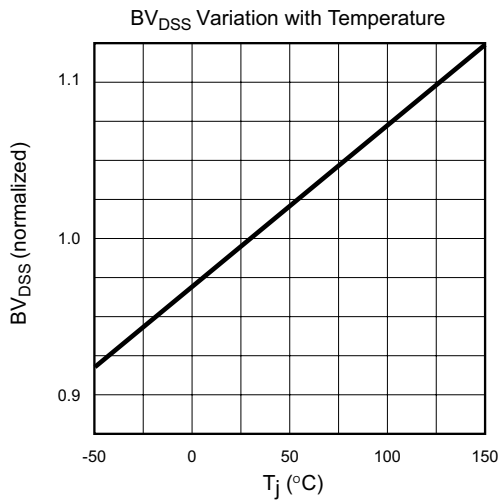
Switching Waveforms and Test Circuit



Typical Performance Curves

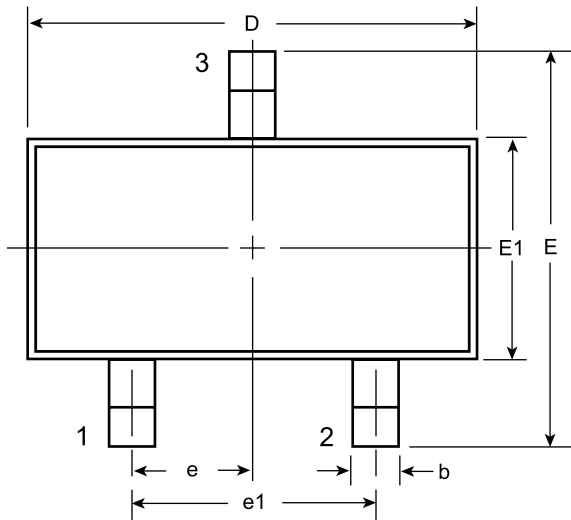


Typical Performance Curves (cont.)

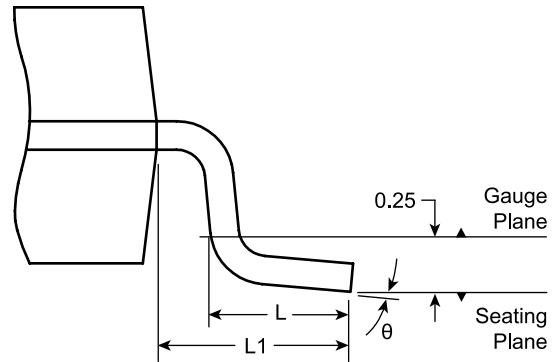


3-Lead TO-236AB (SOT-23) Package Outline (K1/T)

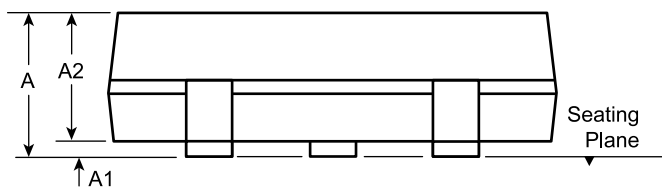
2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch



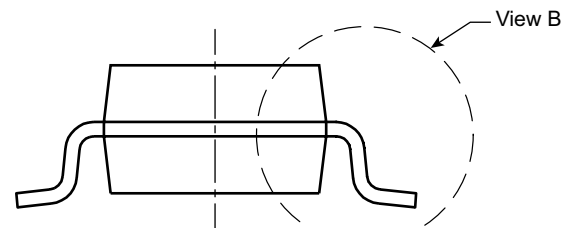
Top View



View B



Side View



View A - A

Symbol	A	A1	A2	b	D	E	E1	e	e1	L	L1	θ	
Dimension (mm)	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.95 BSC	1.90 BSC	0.20 [†]	0.54 REF	0°
	NOM	-	-	0.95	-	2.90	-	1.30			0.50		-
	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40			0.60		8°

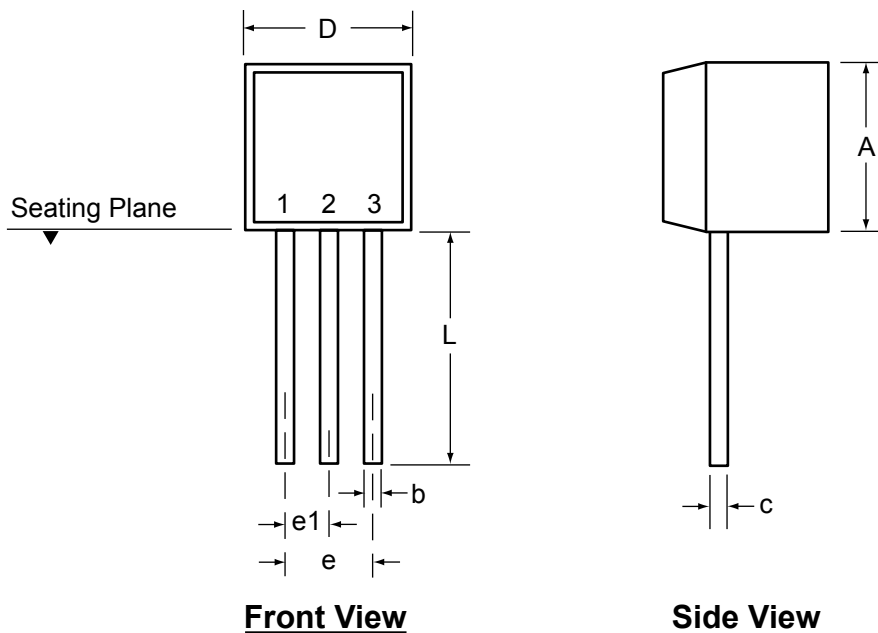
JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

[†] This dimension is a non-JEDEC dimension.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO236ABK1, Version B072208.

3-Lead TO-92 Package Outline (N3)



Symbol		A	b	c	D	E	E1	e	e1	L
Dimensions (inches)	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

* This dimension is not specified in the original JEDEC drawing. The value listed is for reference only.

† This dimension is a non-JEDEC dimension.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version D080408.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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